ROHM

**Products** 

Type

BA05FP

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STRUCTURE

Silicon Monolithic Integrated circuit

TYPE

Low-Dropout Three-Terminal Positive Voltage Regulator

PRODUCT SERIES

BAO5FP

Semiconductor IC

PHYSICAL DIMENSIONS Fig-1 (Plastic Mold)

BLOCK DIAGRAM

Fig-2

FEATURES

1. Maximum output current 1A.

2. Voltage regulator which is stable at 5V is built-in and recommendable for regulators in VCR etc.,

3. Output consist of PNP power transistor and low saturation voltage.

4. Built-in over output current protection circuit prevents IC from being damaged by short.

5. Built-in Thermal Shut Down Circuit for protecting thermal break down.

6. This IC is not susceptible damage due to surge voltage, because it has Over Input Voltage Protection Circuit.

7. Compact because of employment of T0252-3.

### Absolute Maximum Ratings (Ta=25°C)

Symbol	Limits	Unit
Vcc	3 5	V
Ρd	1.0%	W
Topr	-40~+85	°C
Tstg	-55~+150	°C
Vcc Peak	50%%	V
	Vcc Pd Topr Tstg	Vcc     35       Pd     1.0%       Topr     -40~+85       Tstg     -55~+150

※ Derating in done at 8mW/°C for operating above Ta=25°C

※※ Voltage Supply built in time is less than 200msec.(tr≥1msec)

# Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Input Voltage	Vcc	5.0	25.0	V
Output Current	Ιο	-	1	- A

NOTE. The product described in this specification is a strategic product (and/or service) subject to COCOM regulations. It should not be exported without authorization from the appropriate government.

The product described in this specification is designed to be used with ordinary electronic

The product described in this specification is designed to be used with ordinary electronic equipment or devices. (such as audio—visual equipment, office—automation equipment, communications devices, electrical appliances, and electronic toys.).

Should you intend to use this product with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life ( such as medical instruments, transportation equipment, aerospace machinery, nuclear—reactor controllers, fuel controllers and other safety devices.), please be sure to consult with our sales representative in advance. sales representative in advance.

> ROPM assumes no responsibility for the use of any circuits described herein, conveys no license under any patent or other right, and makes no representations that the circuits are free from patent infringement.

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SEP/12/' 96

Specification

Rev. A

Specification No. TSZ02201-BA05FP-1-2

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ELECTRICAL CHARACTERISTICS (Unless otherwise specified, Ta=25°C, Vcc=10V, Io=500mA)

Parameter	Symbol	Limit		IIn;+	II-i+ C. I'-i	TEST	
I al ametel	Symoot	Min	Тур	Max	Unit	Conditions	CIRCUIT
Output Voltage	V <sub>o</sub>	4.75	5.0	5.25	V		Fig-5
Dropout Voltage	ΔVd	_	0.3	0.5	V	Vcc=0.95Vo	Fig-7
Peak Output Current	Ιo	1.0	1.5	_	A		Fig-5
Ripple Rejection	R.R.	45	55	·*	d B	f=120Hz,ein=1Vrms,Io=100mA	Fig-6
Line Regulation	Reg.I	_	20	100	m۷	Vcc=6.0→25.0V	Fig-5
Load Regulation	Reg.L	_	50	150	mV	I₀=5mA→1A	Fig-5
Temperature Coefficie- nt of Output Voltage※	Tovo	<del>_</del>	±0.02		%/°C	I。=5mA, T₁=0∼125°C	Fig-5
Bias Current	Ιb	_	2.5	5.0	mA	Io=0mA	Fig-8
Short-Circuit Output Current	Ios	_	0.4	_	A	Vcc=25V	Fig-9

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NOTE)All characteristics are measured with a capacity across the input of  $0.33\,\mu\text{F}$  and a capacity across the output of  $22\,\mu\text{F}$ .

Measurement is done at Ta=Tj, and variations in the parameter of all measurement (except Temperature Coefficient of Output Voltage) caused by temperature change are not considered.

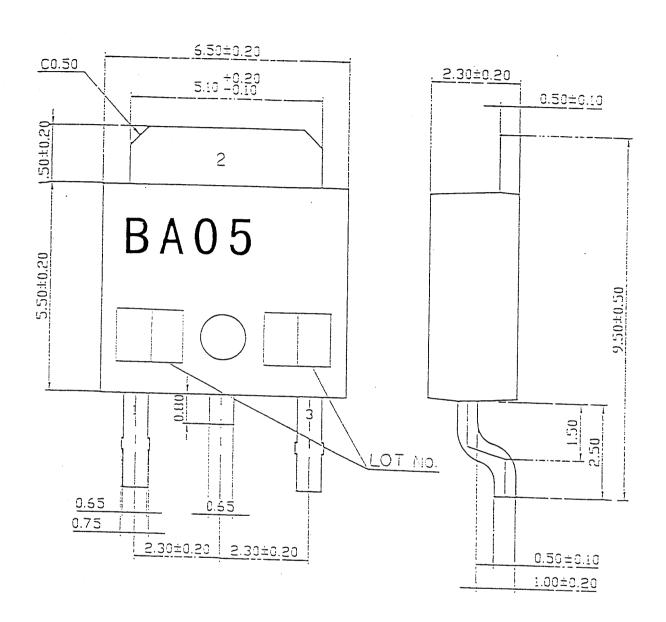
Date SEP/12/ 96 Specification

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O This product is not designed for protection against radioactive rays.

imes Design Guarantee.(Outgoing inspection is not done on all products.)

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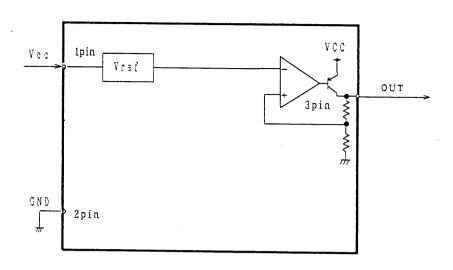
(Units:mm)

1 pin : Vcc 2 pin (FIN) : GND 3 pin : OUT

Fig-1 Physical dimensions ( Plastic Mold )

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Fig-2 Block diagram

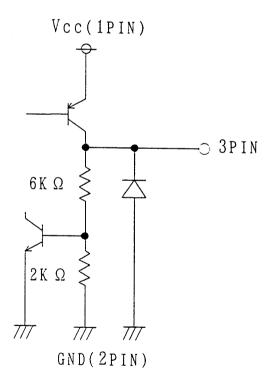
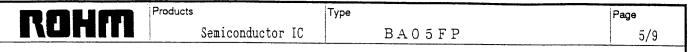


Fig-3 Output equation circuit

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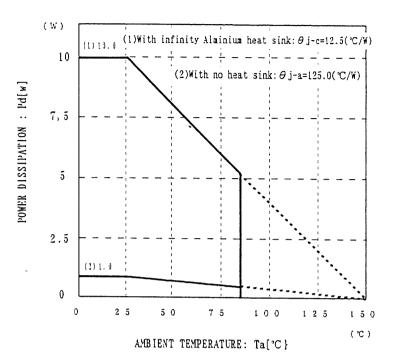
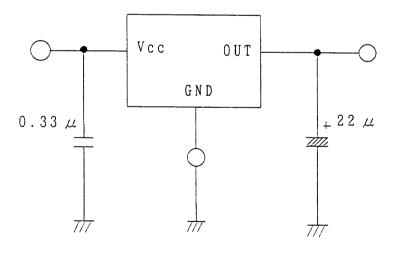
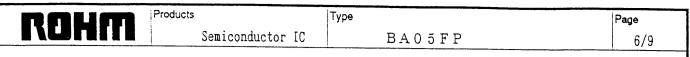


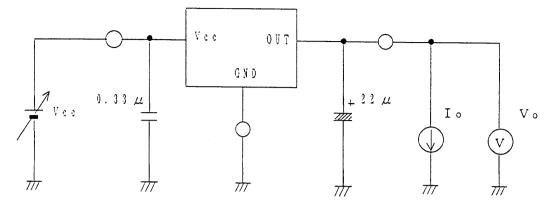
Fig-4 Thermal derating curves



O Standard application circuit

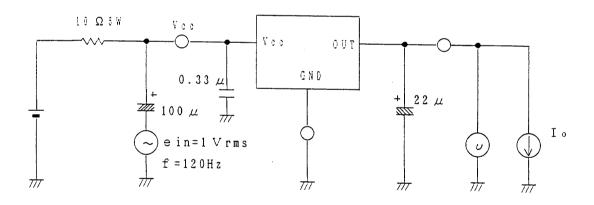
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Output voltage Vcc=10VTemperature Coefficient of Output Voltage Vcc=10VLine Regulation  $Vcc=6.0 \rightarrow 25.0V$ Load Regulation Vcc=10VPeak output current Vcc=10V

Fig-5 Measuring Circuit for Output Voltage, Temperature Coefficient of Output Voltage, Line Regulation, Load Regulation and Peak Output Current.



Vcc=10V

Io = 100 mA

Io = 500mA

Io=500mA

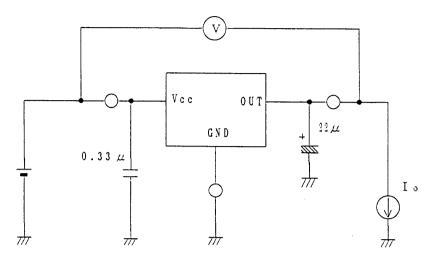
 $Io = 5 \text{ mA} \rightarrow 1 \text{ A}$ 

Io = 5 mA

Fig-6 Measuring Circuit for Ripple Rejection

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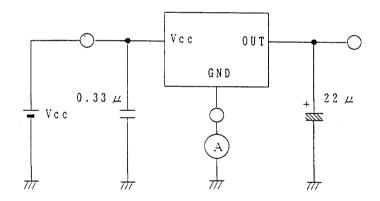
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Vcc=0.95V

Io = 500mA

Fig-7 Measuring Circuit for Dropout Voltage



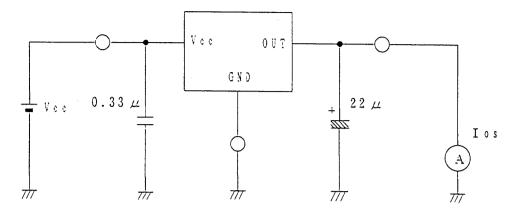
V c c = 1 0 V

 $I \circ = 0 mA$ 

Fig-8 Measuring Circuit for Bias Current

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V c c = 2 5 V (Output-GND short Output Current)

Fig-9 Measuring Circuit for Short-Circuit Output Current

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NOTES FOR USE

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1. The application circuit is recommended for use.

Make sure to confirm the adequacy of the characteristics. When using the circuit with changes to the external circuit constants make sure to leave an adequate margin for external components including static and transitional characteristics as well as dispersion of the IC. Note that ROHM cannot provide adequate confirmation of patents.

#### 2. Operation supply voltage range

Functional circuit operation is guaranteed within operation ambient temperature, as long as it is within operation supply voltage range. The electrical characteristics standard value can not be guaranteed. However, there is no drastic variation in these values, as long as it is within operation supply voltage range.

#### 3. Power dissipation

For the power dissipation, refer to the thermal derating characteristics and the approximation of IC internal power consumption shown in the attached sheet as guidelines. Also, be sure to use this IC within a power dissipation range allowing enough margin.

### 4. Anti-oscillating capacitor of output

Be sure to put the anti-oscillating capacity between GND and output terminals. A tantalum electrolytic capacitor, more than  $10\,\mu\text{F}$ , should be used. The capacitance does not change so much because of its temperature characteristics. We recommend a capacitance of  $0.33\,\mu\text{F}$  near by between input and GND Terminal.

#### 5.0ver-current protection circuit

The over-current protection circuits are built in at the output, according to their respective current outputs and prevent the IC from being damaged when the load is short-circuited or over-current. This protection circuit performs foldback current limiting and is designed allowing a margin not to latched by the current limitation when an over-current flows in the IC instantaneously through a large capacitor. When output is less than  $1V_{\text{F}}$ , it is judged as a short circuit mode and IC does not operate.

## 6.Built-in thermal circuit

A temperature control circuit is built in the IC to prevent the damage due to overheat. Therefore, all the outputs are turned off when the thermal circuit works and are turned on when the temperature goes down to the specified level.

#### 7. Grounding

For the grounding shown in the application circuit, wire every ground to GND terminal (2-Pin) in a short pattern arrangement to avoid electrical disturbance.

# 8.Miscellaneous

This product are produced with struct quality control, but mite be destroyed in using beyond absolute maximum ratings. Once IC destroyed a failure mode cannot be defined (like Short mode, or Open mode). Therefore physical security countermeasure, like fuse, is to be given when a specific mode to be beyond absolute maximum ratings is considered.

9.Mal-function may happen when the device is used in the strong electro-magnetic field.

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